TOSHIBA GATE TURN-OFF THYRISTOR LOW SNUBBER TYPE

SG600GXH26

INVERTER APPLICATION

Repetitive Peak Off-State Voltage $: V_{DRM} = 4500V$

R.M.S On-State Current $: I_{T(RMS)} = 300A$

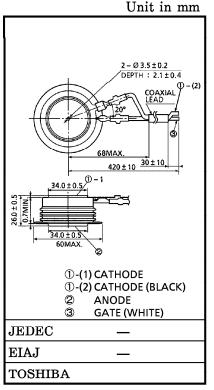
Peak Turn-Off Current : $I_{TGQM} = 600A$

Critical Rate of Rise of On-State Current : $di/dt = 600A/\mu s$

Critical Rate of Rise of Off-State Voltage : $dv/dt = 1200V/\mu s$

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Repetitive Peak Off-state Voltage, (Note. 1)	$V_{ m DRM}$	4500	v
Repetitive Peak Reverse Voltage	v_{RRM}	16	V
Peak Turn-Off Current (Note. 2)	ITGQM	600	A
R.M.S On-State Current (Note. 3)	IT (RMS)	300	A
Peak One Cycle Surge On-State Current (non repetitive, 10ms width half sine waveform)	I_{TSM}	4000	A
Critical Rate Of Rise Of On-State Current (Note. 4)	di / dt	600	A/μs
Peak Gate Current	I_{GM}	280	Α
Average Gate Power Dissipation	P _G (AV)	55	W
R.M.S Gate Current (Note. 5)	I _G (RMS)	35	Α
Peak Reverse Gate Voltage (at Static)	v_{RGM}	16	V
Operating Junction Temperature Range	$T_{ m j}$	-40~125	°C
Storage Temperature Range	$T_{ m stg}$	-40~150	°C
Mounting Force	_	11.8±1.2	kN



Weight: 320g

Note. 1 $V_{GK} \le -2V$

Note. 2 $V_{DM} \le 4000V$, $C_s \ge 0.5 \mu F$, $di_{QQ} / dt \ge 20A / \mu s$, $L_s \le 0.2 \mu H (V_{DSP} \le 650V)$

Note 3 50Hz Half Sine Waveform at $T_f \le 85^{\circ}C$

Note. 4 $V_D \le 2250V$, $I_{GM} \ge 20A$ ($t_r \le 1\mu s$)

Note. 5 Ambient Temperature of coaxial gate-cathode lead ≤ 90°C

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ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
Repetitive Peak Off-State Current	$I_{ m DRM}$	$V_{ m DRM} = 4500 m V, \ V_{ m GK} = -2 m V, \ T_j = 125 m ^{\circ} C$		_	_	20	mA
Repetitive Peak Reverse Current	$I_{ m RRM}$	V _{RRM} =16V, T _j =125°C		_	_	10	mA
Repetitive Peak Reverse Gate Current	$I_{ m RGM}$	$V_{ m RGM} = 16 V, T_{ m j} = 125 { m ^{\circ} C}$		_	_	10	mA
Peak On-State Voltage	$V_{ extbf{TM}}$	$I_{TM} = 600A, T_j = 125$ °C			_	4.0	V
Gate Trigger Voltage	V_{GT}	$V_D = 24V,$ $R_L = 0.1\Omega$	$T_j = -40^{\circ}C$	_	_	1.5	V
			$T_j = 25$ °C		_	1.0	
Gate Trigger Current	I_{GT}		$T_j = -40$ °C	_	_	4.5	A
			$T_j = 25$ °C	_	_	1.5	
Turn-On Delay Time	t_{d}	$V_{ m D}\!=\!2250{ m V},~I_{ m TM}\!=\!600{ m A}, \ { m di}/{ m dt}\!=\!600{ m A}/\mu{ m s}, \ { m I}_{ m GM}\!=\!20{ m A}({ m t}_{ m r}\!=\!1\mu{ m s}), \ { m T}_{ m j}\!=\!25^{\circ}{ m C}$		_	_	3.0	μs
Turn-On Time	t_{gt}			_	_	10.0	μ s
Critical Rate Of Rise Of Off-State Voltage	dv / dt	$V_{\mbox{DRM}} = 3000 \mbox{V}, V_{\mbox{GK}} = -2 \mbox{V},$ Exponential Rise, $T_{\mbox{\scriptsize j}} = 125 \mbox{^{\circ}C}$		1200	_	_	V/μs
Storage Time	t_{s}	$I_{TGQ} = 600A,$ $V_{D} = 2250V, V_{DM} = 4000V,$ $C_{S} = 0.5 \mu F, T_{j} = 125 ^{\circ}C,$ $di_{GQ} / dt = 20A / \mu s,$ Off Squeeze Current $\geq 500 mA$		_	_	15	μ s
Gate Turn-Off Time	\mathbf{t}_{gq}				_	17	μs
Gate Turn-Off Current	$I_{ ext{GQ}}$			_	250	_	Α
Tail Time	$t_{ m tail}$			_	_	40	μs
Thermal Resistance (Junction to Fin)	R _{th (j-f)}	DC		_	_	0.045	°C/W

